APPLICATION DATA SHEET

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Title of Invention

[CHIP PACKAGE STRUCTURE]

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Correspondence address:

Customer Number: 31561

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Inventors Information:

Inventor 1:

Applicant Authority Type: Inventor Citizenship: TW
Name prefix: Mr.

Given Name: Ming-Lun

Family Name: Ho

Residence:

City of Residence: Kaohsiung

Country of Residence: TW

Address-1 of Mailing Address: No.67-26, Bauan Rd., Yungan Shiang

Address-2 of Mailing Address:

City of Mailing Address: Kaohsiung

State of Mailing Address:

Postal Code of Mailing Address: 828
Country of Mailing Address: TW

Phone: Fax:

E-mail:

Inventor 2:

Applicant Authority Type: Inventor

Citizenship: TW

Name prefix: Mr.

Given Name: Yu-Wen Family Name: Chen

Residence:

City of Residence: Kaohsiung

Country of Residence: TW

Address-1 of Mailing Address: 9Fl., No.582-1, Heti Rd., Sanmin Chiu

Address-2 of Mailing Address:

City of Mailing Address: Kaohsiung

State of Mailing Address:

Postal Code of Mailing Address:

Country of Mailing Address: TW

Phone:

Fax:

E-mail:

Attorney Information:

practitioner(s) at Customer Number:

31561

as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.